

TMS2018 熱電シンポジウムのお知らせ

国際交流委員会委員長
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活発な熱電材料シンポジウムが開催される TMS2018 のお知らせです。奮ってご参加下さい。

次ページに HP のご案内がございます。

国際会議名：TMS2018

日時： 2018 年 3 月 26 日～3 月 2 日

場所： フェニックス、アメリカ

ホームページ：

(全体) <http://www.tms.org/tms2018>

(熱電シンポジウム、アブストラクト投稿ページ)

<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>

アブストラクト切： 7 月 15 日 2017 年まで延長されております。

TMS 2018
147th Annual Meeting & Exhibition
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MARCH 11 - 15, 2018
PHOENIX, ARIZONA

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MEETING NEWS
Request a Visa Invitation Letter
Posted on: June 26, 2017

Many TMS2018 presenters will travel to Phoenix, Arizona, from other countries to attend TMS2018. Those presenters who require a travel visa to enter the United States are encouraged to [request a visa invitation letter](#) now and to begin the process of applying for a travel visa today.

CALL FOR PAPERS

Alloys and Compounds for Thermoelectric and Solar Cell Applications VI

2018 TMS Annual Meeting at Phoenix, Arizona
March 11 - March 15, 2018

This symposium addresses synthesis, property measurements, phase stability, phase transformation of the alloys and compounds used in the thermoelectric and solar cell devices. Materials of interests include, but not limited to, skutterudites, superlattice, half-heusler alloys, CdTe, CIS, CIGS, CZTS and new materials for thermoelectric and solar cell applications. Abstracts are due by July 1st, 2017. Please submit abstracts directly to TMS Online.

(<http://www.tms.org/tms2018>)

(<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>).

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